

## Power line chokes

Current-compensated ring core double chokes  
250 V AC, 1.0 ... 6.25 mH, 10 ... 17 A / +70 °C

**Series/Type:**            **B8272\*V2\*U\***

**Date:**                    April 2020

**Rated voltage 250 V AC**

**Rated current 10 A ... 17 A / +70 °C**

**Nominal inductance 1.0 mH ... 6.25 mH**

### Construction

- Current-compensated ring core double choke
- Ferrite core with epoxy coating (UL 94 V-0)
- Plastic base plate (UL 94 V-0, CTI600)
- Plastic spacer (UL 94 V-0, CTI600)
- Glue
- Sector winding
- Clearance distances  $\geq 3$  mm

### Features

- Plastic material complies with EN 60335-1, clause 30<sup>1)</sup>
- High resonance frequency
- Approx. 0.4% stray inductance for symmetrical interference suppression
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2)
- RoHS-compatible

### Applications

- Suppression of common-mode interferences
- Switch-mode applications
- Frequency converters
- Household appliances (white goods)

### Terminals

- Ends of winding wires
- Hot-dip tinned
- Lead spacing 10 × 20 mm

### Marking

- Product brand (EPCOS), ordering code, graphic symbol, rated current, rated voltage, nominal inductance, date of manufacture (YYWWD.internal ID code), production place identification code

### Delivery mode

- Cardboard box



Size A



Size B/C

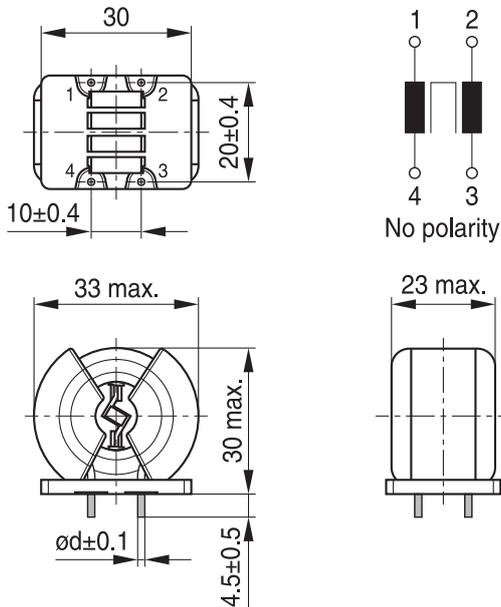
1) Certified values:

Glow wire flammability index (GWFI to IEC 60695-2-12):	+850 °C
Glow wire ignition temperature (GWIT to IEC 60695-2-13):	+775 °C
Comparative tracking index (CTI to IEC 60112):	600 V
Ball pressure test (BP to IEC 60695-10-2):	+190 °C

Current-compensated ring core double chokes

Dimensional drawings and pin configurations

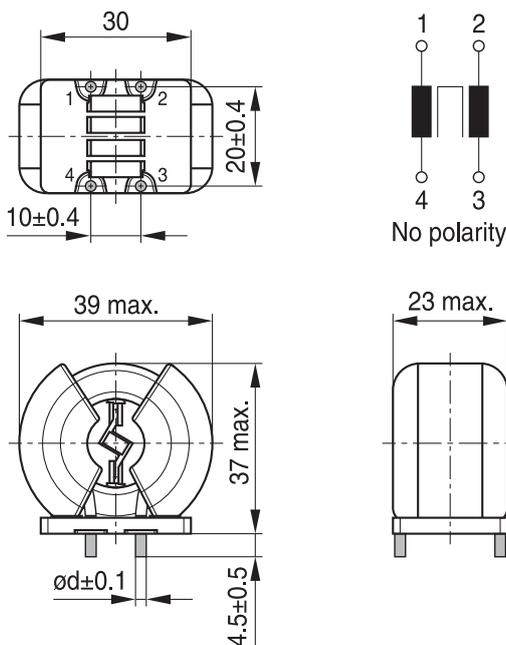
Size A



Part tolerances to ISO 2768-c / ISO 8015  
 Size ISO 14405 (E)   
 All dimensions in mm

IND1618-7-E

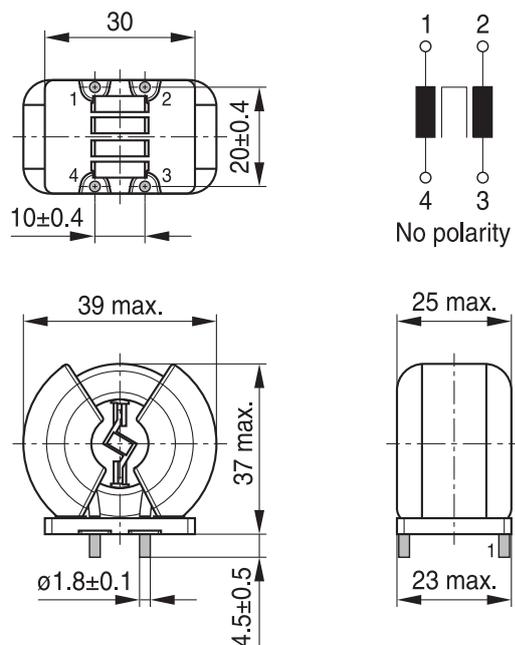
Size B



Part tolerances to ISO 2768-c / ISO 8015  
 Size ISO 14405 (E)   
 All dimensions in mm

IND1617-6-E

Size C



Part tolerances to ISO 2768-c / ISO 8015  
 Size ISO 14405 (E)   
 All dimensions in mm

IND1619-8-E

**Technical data and measuring conditions**

Rated voltage $V_R$	250 V AC (50/60 Hz)
Test voltage $V_{test}$	1800 V AC, 2 s (line/line)
Rated temperature $T_R$	+70 °C
Rated current $I_R$	Free air convection cooling, referred to 50 Hz and rated temperature
Nominal inductance $L_N$	Measured with Agilent 4284A at 0.1 mA, +20 °C Measuring frequency: $L_R \leq 1$ mH: $f=100$ kHz $L_R > 1$ mH: $f= 10$ kHz Inductance is specified per winding.
Inductance tolerance	-30/+50% at +20 °C
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with $I_R$ , +20 °C
Stray inductance $L_{stray,typ}$	Measured with Agilent 4284A at 5 mA, +20 °C Measuring frequency: $L_N \leq 1$ mH: $f=100$ kHz $L_N > 1$ mH: $f= 10$ kHz Typical values.
DC resistance $R_{typ}$	Measured at +20 °C, typical values, specified per winding
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 ±3) °C, (3 ±0.3) s Wetting of soldering area ≥ 95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions (packaged)	-25 °C ... +40 °C, ≤ 75% RH

**Characteristics and ordering codes**
**Size A**

$I_{R,+70\text{ °C}}$ A	$L_N$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ m $\Omega$	Lead diameter d mm	Weight approx. g	Ordering code
10.0	3.30	11.0	9.2	1.25	45	B82724V2103U040
12.0	1.50	7.0	6.3	1.25	40	B82724V2123U040
17.0	1.00	3.6	3.2	1.60	45	B82724V2203U040 <sup>1)</sup>

1) Alternative rating: 20 A at +60 °C

**Size B**

$I_{R,+70\text{ °C}}$ A	$L_N$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ m $\Omega$	Lead diameter d mm	Weight approx. g	Ordering code
10.0	6.25	27.0	11.0	1.50	75	B82725V2103U041
11.5	5.00	22.0	8.2	1.60	70	B82725V2103U040 <sup>1)</sup>
12.0	3.60	14.0	7.8	1.50	70	B82725V2123U040

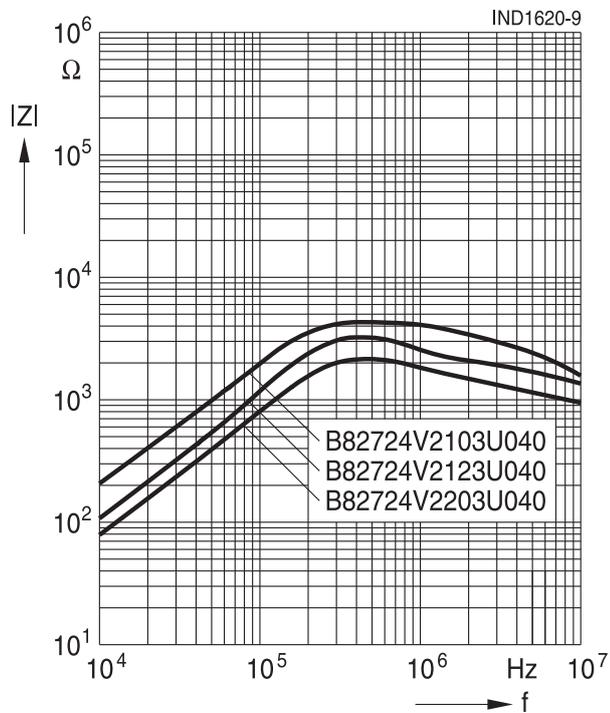
1) Alternative rating: 10 A at +85 °C

**Size C**

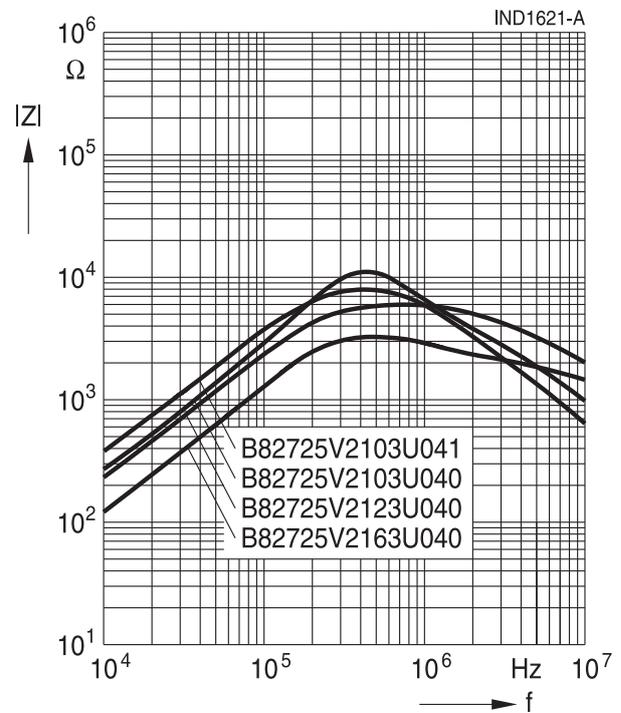
$I_{R,+70\text{ °C}}$ A	$L_N$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ m $\Omega$	Lead diameter d mm	Weight approx. g	Ordering code
16	2.0	9.0	4.2	1.80	65	B82725V2163U040

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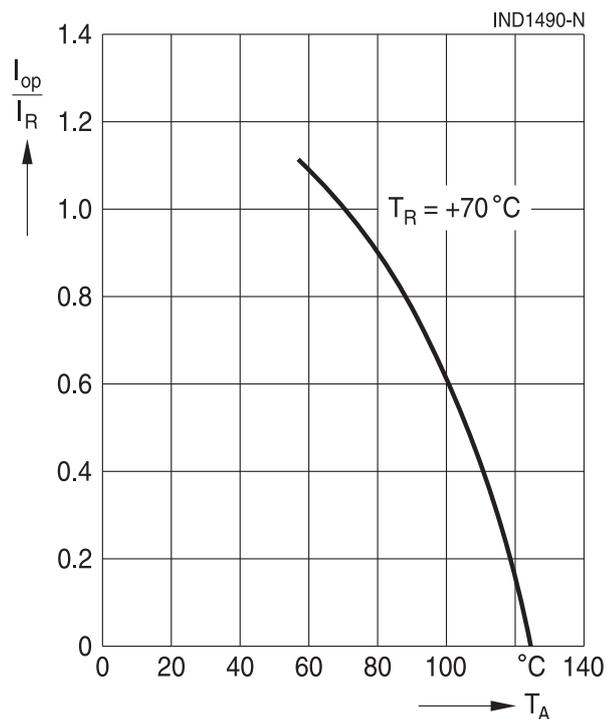
**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20 °C,  
typical values



**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20 °C,  
typical values



**Current derating  $I_{op}/I_R$**   
**versus temperature  $T_A$**   
rated temperature +70 °C



## Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.  
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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## Important notes

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